

IRFW720B / IRFI720B

400V N-Channel MOSFET

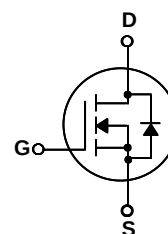
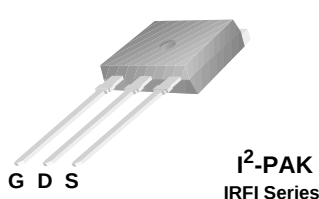
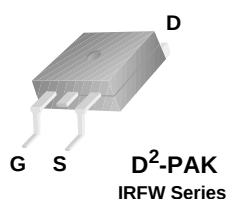
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supplies and electronic lamp ballasts based on half bridge.

Features

- 3.3A, 400V, $R_{DS(on)} = 1.75\Omega$ @ $V_{GS} = 10$ V
- Low gate charge (typical 14 nC)
- Low C_{rss} (typical 11 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	IRFW720B / IRFI720B	Units
V_{DSS}	Drain-Source Voltage	400	V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	3.3	A
	- Continuous ($T_C = 100^\circ\text{C}$)	2.1	A
I_{DM}	Drain Current - Pulsed (Note 1)	13.2	A
V_{GSS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy (Note 2)	240	mJ
I_{AR}	Avalanche Current (Note 1)	3.3	A
E_{AR}	Repetitive Avalanche Energy (Note 1)	4.9	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	5.5	V/ns
P_D	Power Dissipation ($T_A = 25^\circ\text{C}$) *	3.13	W
	Power Dissipation ($T_C = 25^\circ\text{C}$)	49	W
	- Derate above 25°C	0.39	W/ $^\circ\text{C}$
T_J, T_{stg}	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	--	2.57	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *	--	40	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	--	62.5	$^\circ\text{C/W}$

* When mounted on the minimum pad size recommended (PCB Mount)

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	400	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\text{ }\mu\text{A}$, Referenced to 25°C	--	0.4	--	V/ $^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 400\text{ V}, V_{GS} = 0\text{ V}$	--	--	10	μA
		$V_{DS} = 320\text{ V}, T_C = 125^\circ\text{C}$	--	--	100	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$	--	--	-100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2.0	--	4.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 1.65\text{ A}$	--	1.4	1.75	Ω
g_{FS}	Forward Transconductance	$V_{DS} = 40\text{ V}, I_D = 1.65\text{ A}$ (Note 4)	--	2.8	--	S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$	--	460	600	pF
C_{oss}	Output Capacitance		--	55	72	pF
C_{rss}	Reverse Transfer Capacitance		--	11	15	pF

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 200\text{ V}, I_D = 3.3\text{ A},$ $R_G = 25\text{ }\Omega$ (Note 4, 5)	--	10	30	ns
t_r	Turn-On Rise Time		--	35	80	ns
$t_{d(off)}$	Turn-Off Delay Time		--	35	80	ns
t_f	Turn-Off Fall Time		--	35	80	ns
Q_g	Total Gate Charge	$V_{DS} = 320\text{ V}, I_D = 3.3\text{ A},$ $V_{GS} = 10\text{ V}$ (Note 4, 5)	--	14	18	nC
Q_{gs}	Gate-Source Charge		--	2.7	--	nC
Q_{gd}	Gate-Drain Charge		--	5.6	--	nC

Drain-Source Diode Characteristics and Maximum Ratings

I _S	Maximum Continuous Drain-Source Diode Forward Current		--	--	3.3	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	13.2	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 3.3 A	--	--	1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 3.3 A, dI _F / dt = 100 A/μs (Note 4)	--	220	--	ns
Q _{rr}	Reverse Recovery Charge		--	1.36	--	μC

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L = 39\text{ mH}, I_{AS} = 3.3\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\text{ }\Omega$, Starting $T_J = 25^\circ\text{C}$
3. $I_{SD} \leq 3.3\text{ A}, di/dt \leq 300\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$
5. Essentially independent of operating temperature

Typical Characteristics

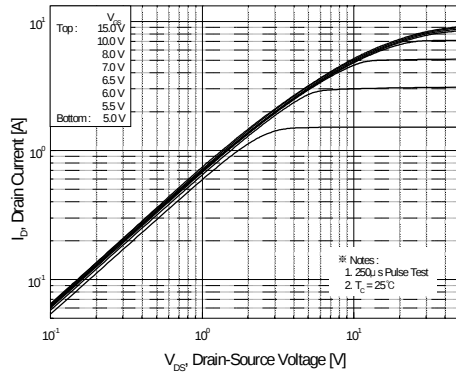


Figure 1. On-Region Characteristics

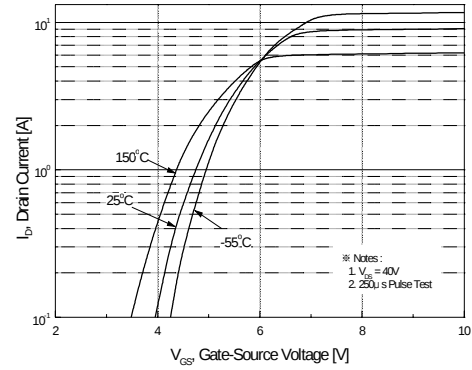


Figure 2. Transfer Characteristics

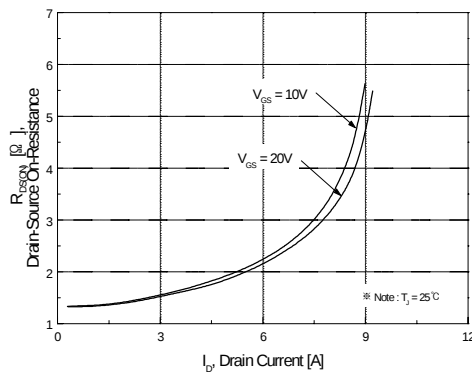


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

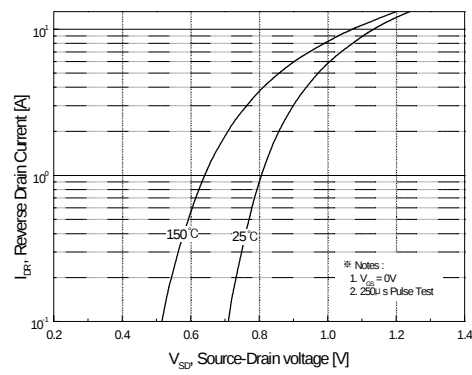


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

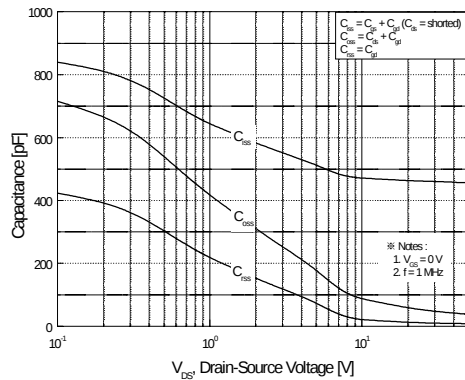


Figure 5. Capacitance Characteristics

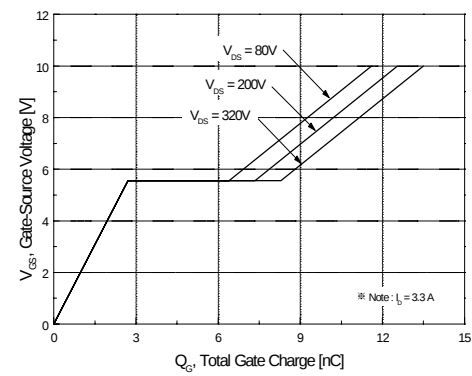


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

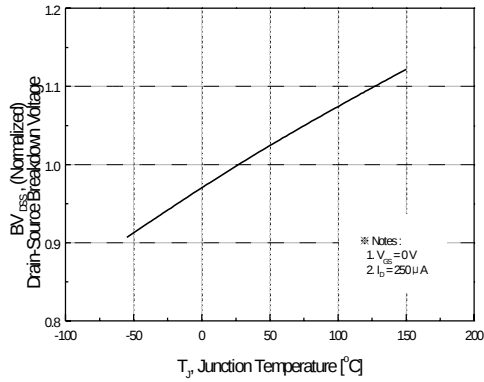


Figure 7. Breakdown Voltage Variation vs Temperature

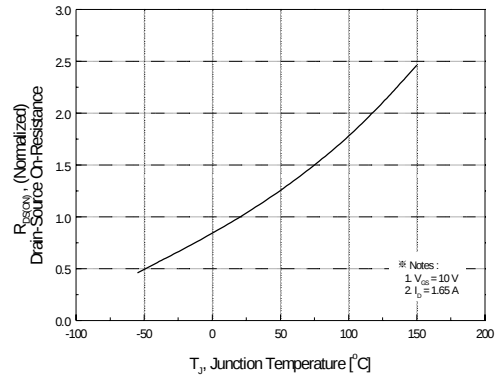


Figure 8. On-Resistance Variation vs Temperature

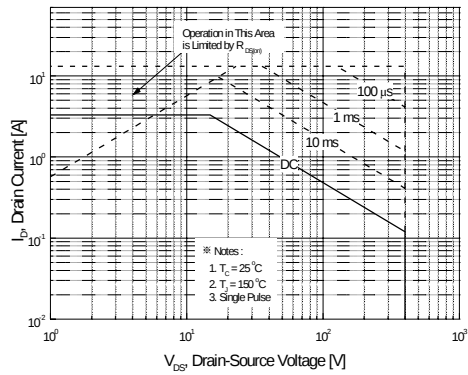


Figure 9. Maximum Safe Operating Area

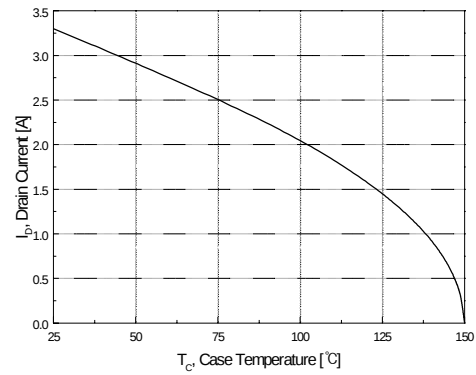


Figure 10. Maximum Drain Current vs Case Temperature

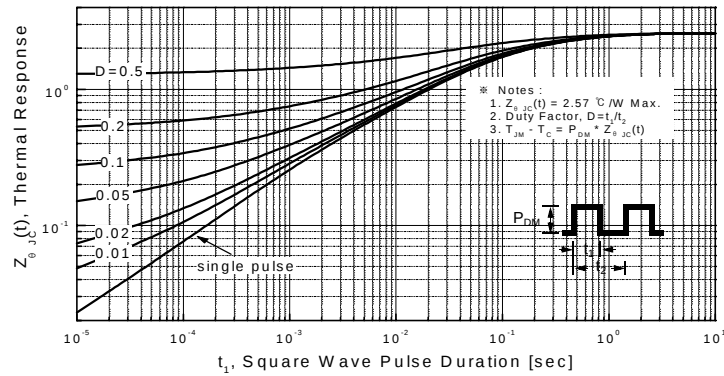
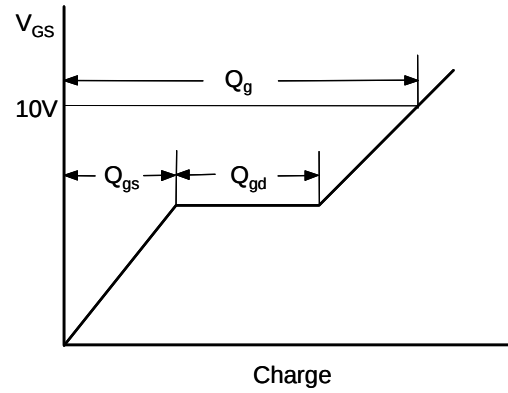
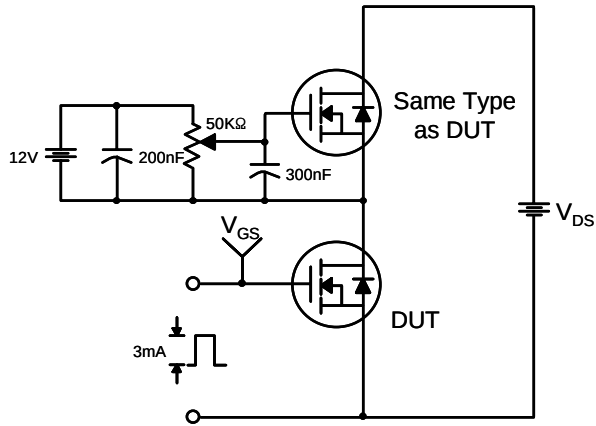
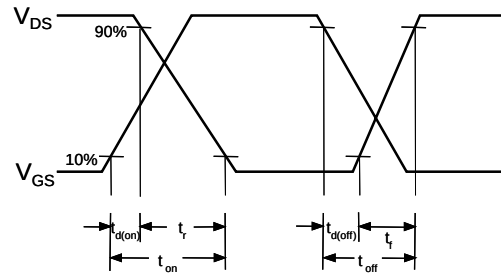
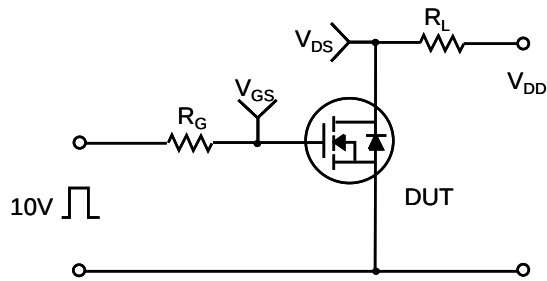


Figure 11. Transient Thermal Response Curve

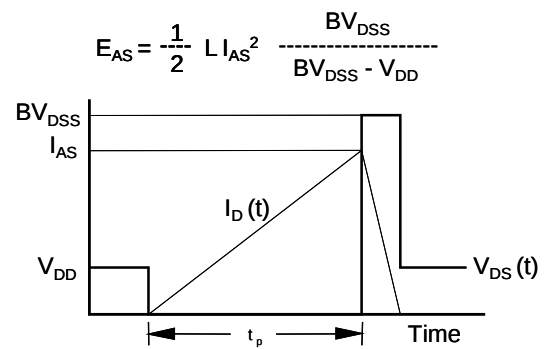
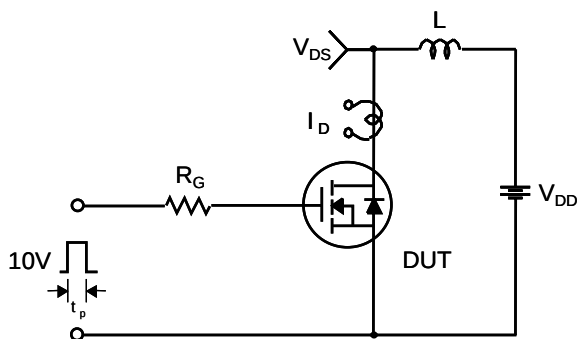
Gate Charge Test Circuit & Waveform



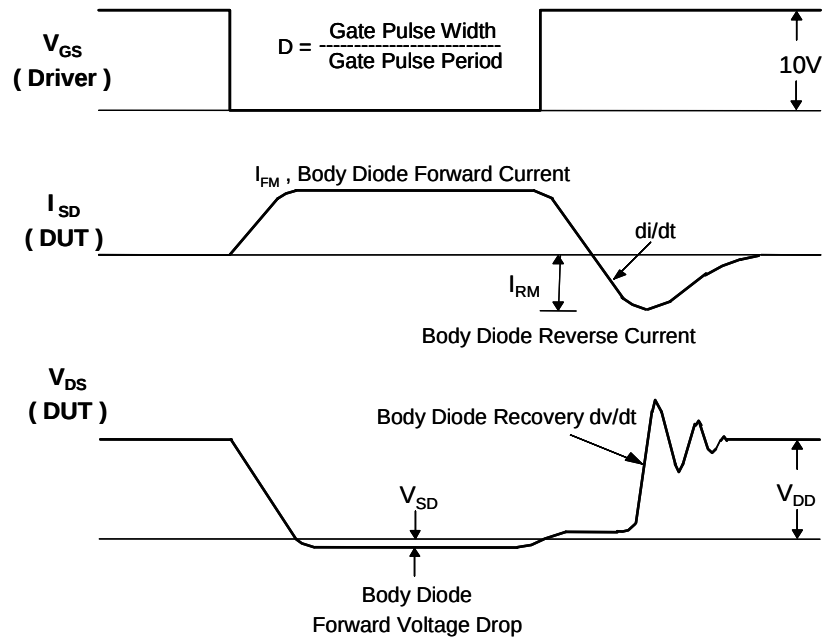
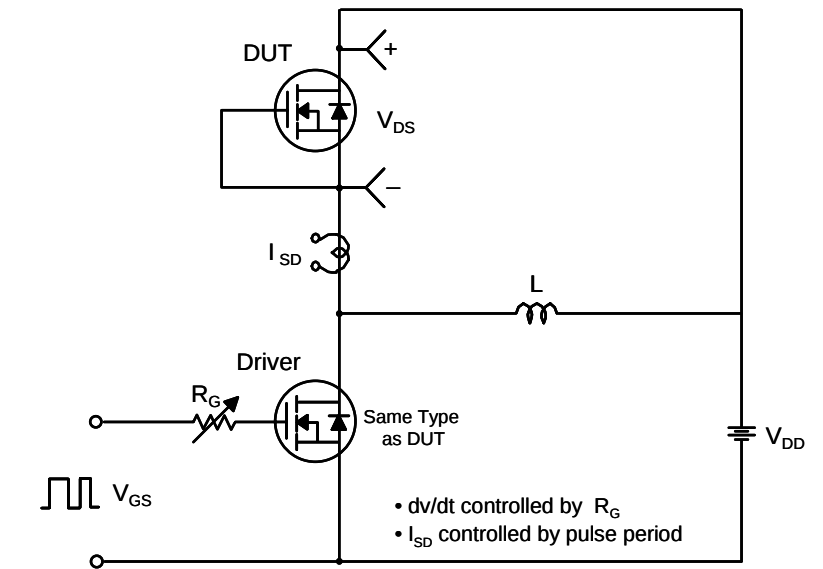
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

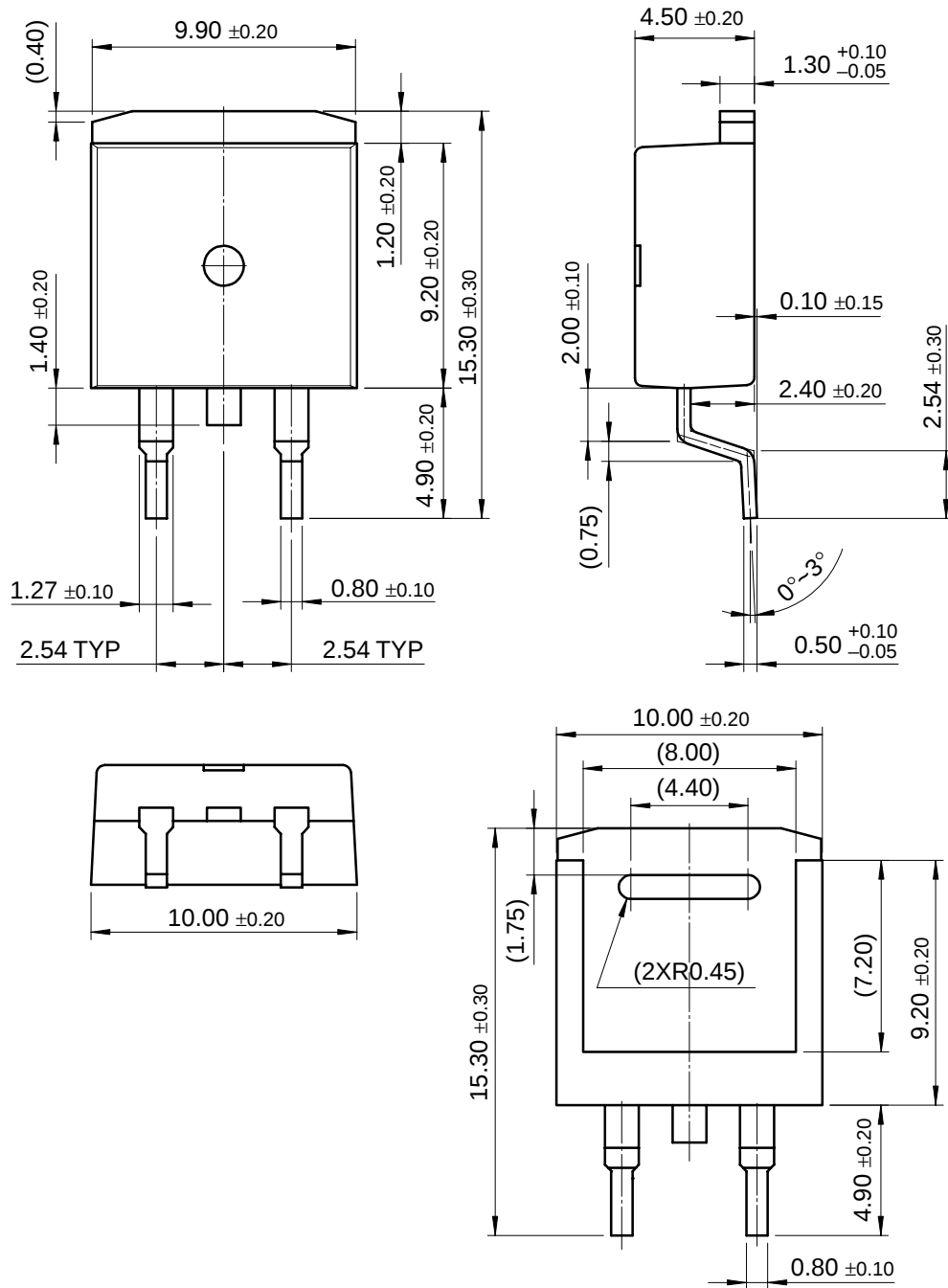


Peak Diode Recovery dv/dt Test Circuit & Waveforms



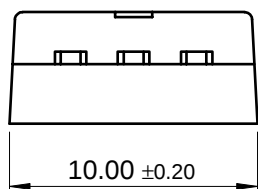
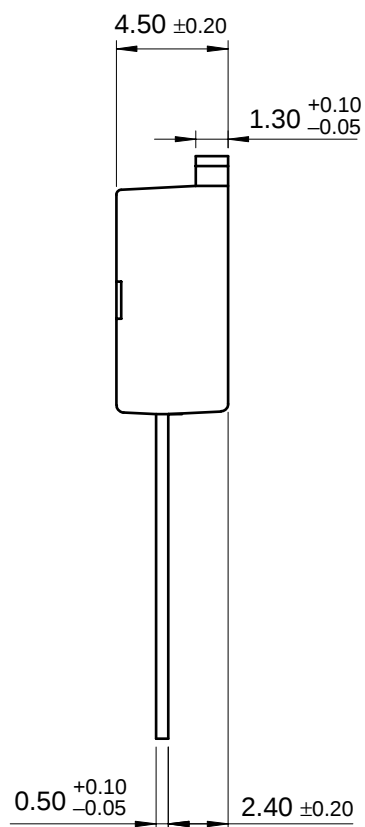
Package Dimensions

D²-PAK



Dimensions in Millimeters

Technical drawing of a 3-pin connector. The drawing shows a top view of the connector with three pins. The overall width is 9.90 ±0.20 inches (251.46 ±5.08 mm). The overall height is 13.08 ±0.20 inches (332.40 ±5.08 mm). The distance between the centers of the pins is 2.54 TYP inches (63.5 mm). The distance from the center of the pins to the center of the mounting hole is 1.27 ±0.10 inches (32.26 ±2.54 mm). The distance from the center of the pins to the bottom edge is 10.08 ±0.20 inches (256.40 ±5.08 mm). The distance from the center of the pins to the top edge is 1.20 ±0.20 inches (30.48 ±5.08 mm). The distance from the center of the pins to the side edge is 1.47 ±0.10 inches (37.34 ±2.54 mm). The distance from the center of the pins to the side edge is 0.80 ±0.10 inches (20.32 ±2.54 mm). The distance from the center of the pins to the side edge is 1.46 inches (37.09 mm). The distance from the center of the pins to the side edge is 0.94 inches (23.81 mm). The distance from the center of the pins to the side edge is 1.20 ±0.20 inches (30.48 ±5.08 mm). The distance from the center of the pins to the side edge is 9.20 ±0.20 inches (233.04 ±5.08 mm). The distance from the center of the pins to the side edge is MAX 13.40 inches (340.40 mm). The distance from the center of the pins to the side edge is MAX 3.00 inches (76.20 mm). The distance from the center of the pins to the side edge is 45°.



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* 1,000 piece Budgetary Pricing

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